

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MIN-TSUN HSIEH	03/15/2011
WEN-LIANG TSENG	03/15/2011
LUNG-HSIN CHEN	03/15/2011
CHIH-YUNG LIN	03/15/2011
CHING-LIEN YEH	03/15/2011
CHI-WEI LIAO	03/11/2011
RECEIVING PARTY DATA	
Name:	ADVANCED OPTOELECTRONIC TECHNOLOGY, INC.
Street Address:	No. 13, Gongye 5th RD., Hsinchu Industrial Park,Hukou Shiang
City:	Hsinchu Hsien 303
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13113081
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	Raymond J. Chew
Total Attachments: 2 source=US32767110518ASM#page1.tif source=US32767110518ASM#page2.tif	

CH \$40.00 13113081

**ASSIGNMENT**

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. MIN-TSUN HSIEH , residing at Hukou, Hsinchu, Taiwan
- 2. WEN-LIANG TSENG , residing at Hukou, Hsinchu, Taiwan
- 3. LUNG-HSIN CHEN , residing at Hukou, Hsinchu, Taiwan
- 4. CHIH-YUNG LIN , residing at Hukou, Hsinchu, Taiwan
- 5. CHING-LIEN YEH , residing at Hukou, Hsinchu, Taiwan
- 6. CHI-WEI LIAO , residing at Hukou, Hsinchu, Taiwan
- 7. \_\_\_\_\_ , residing at \_\_\_\_\_
- 8. \_\_\_\_\_ , residing at \_\_\_\_\_

hereby sell(s), assign(s) and transfer(s) unto: **ADVANCED OPTOELECTRONIC TECHNOLOGY, INC.** having a principal place of business at **No. 13, Gongye 5th Rd., Hsinchu Industrial Park, Hukou Shiang, Hsinchu Hsien 303, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **LIGHT-EMITTING ELEMENT PACKAGE AND FABRICATION METHOD THEREOF** for which the undersigned

[ ] previously executed --- Ser. No. \_\_\_\_\_ and filing date of \_\_\_\_\_  
[ x ] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>MIN-TSUN HSIEH</u> MIN-TSUN HSIEH	<u>2011-3-15</u> Date
2.	<u>Wen-Liang Tseng</u> WEN-LIANG TSENG	<u>2011-3-15</u> Date
3.	<u>Lung-Hsin Chen</u> LUNG-HSIN CHEN	<u>2011-3-15</u> Date
4.	<u>CHIH-YUNG LIN</u> CHIH-YUNG LIN	<u>2011-3-15</u> Date
5.	<u>CHING-LIEN YEH</u> CHING-LIEN YEH	<u>2011-3-15</u> Date
6.	<u>Chi-Wei Liao</u> CHI-WEI LIAO	<u>2011-3-11</u> Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date